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<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT (6 Pages)
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT (# Month)
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NAME OF INVENTOR(S): Yew	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/612,129 Filing Date: 7/2/2003	
TITLE OF INVENTION: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE	
TI FILE NO.: TI-26239.1	DEPOSIT ACCT. NO.: 20-0668
FAXED: 05/21/2004 DUE: 06/01/2004 ATTY/SEC'Y: WDS/tlc	

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Texas Instruments Incorporated
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MAY 21 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yew
Serial No: 10/612,129
Filed: 7/2/2003
For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC
SUBSTRATE

Docket No: TI-26239.1
Examiner: Cao, Phat X.
Art Unit: 2814

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AMENDMENT UNDER 37 C.F.R. § 1.115

Assistant Commissioner For Patents
Washington, DC 20231

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Dear Sir:

Responsive to the Office Action mailed March 1, 2004 in connection with the
above identified application, Applicants respectfully submit the following amendments
and remarks.